Packaging Technique for the Fabrication of Polarized Light Emitting Diodes
Tech ID: 22792 / UC Case 2005-614-0

BRIEF DESCRIPTION
A polarized LED and a method of fabricating and packaging the device.

BACKGROUND
It has recently become possible to prepare AlInGaN LEDs on a-planes and m-planes. These LEDs exhibit linearly polarized light emission. The polarization field is in a particular direction (c-direction) in the plane, and the stress in the QW is anisotropic due to different degrees of lattice mismatch between the substrate and QW in the two perpendicular directions in the plane. Linearly polarized light is an electromagnetic wave that has its electric field only in one plane perpendicular to its propagation. Non-polarized light has its electric field evenly distributed in directions in planes perpendicular to its propagation. A principle application for polarized light is backlighting for liquid crystal displays (LCDs), in which LEDs are beneficial due to their compactness and energy efficiency compared to conventional cold cathode fluorescent tubes. Nitride-based LEDs prepared on a semi-polar plane have also been confirmed to emit polarized light. What is needed is a simplified method of fabricating polarized LEDs and packaging such LEDs.

DESCRIPTION
Researchers at the University of California, Santa Barbara have developed a polarized LED and a method of fabricating and packaging the device. The LED may be attached in a favorable orientation with respect to a package, so that the light polarization direction of emitted light from the package is apparent. The package may include at least one additional marker indicating the light polarization direction. Regardless, if a LCD is large (as for a television screen) or small (as for a cell phone screen), multiple LEDs are used to obtain sufficient brightness. To use an LED array as a linearly polarized light source, the orientation of each die must match. To fabricate these LED arrays as polarized light sources, the marker technique of this technology will make the whole production process simple and reliable, from die attachment into a package to final display unit assembling.

ADVANTAGES
▶ Simple and reliable process

APPLICATIONS
▶ Polarized LEDs (manufacturing and packaging)

This technology is available for licensing.

PATENT STATUS

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<td>United States Of America</td>
<td>Issued Patent</td>
<td>7,518,159</td>
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RELATED CASES
2005-614-0

CATEGORIZED AS
▶ Engineering
▶ Optics and Photonics
▶ All Optics and Photonics
▶ Semiconductors
▶ Design and Fabrication

ADDITIONAL TECHNOLOGIES BY THESE INVENTORS
▶ Method for Improved Surface of (Ga,Al,In,B)N Films on Nonpolar or Semipolar Subtrates
High Efficiency LED with Optimized Photonic Crystal Extractor
Enhanced Optical Polarization of Nitride LEDs by Increased Indium Incorporation
Lateral Growth Method for Defect Reduction of Semipolar Nitride Films
Flexible Arrays of MicroLEDs using the Photoelectrochemical (PEC) Lift-off Technique
Vertical Cavity Surface-Emitting Lasers with Continuous Wave Operation
Low-Cost Zinc Oxide for High-Power-Output, GaN-Based LEDs (UC Case 2010-183)
Internal Heating for Ammonothermal Growth of Group-III Nitride Crystals
Defect Reduction in GaN films using in-situ SiNx Nanomask
Enhanced Light Extraction LED with a Tunnel Junction Contact Wafer Bonded to a Conductive Oxide
Highly Efficient Blue-Violet III-Nitride Semipolar Laser Diodes
Hybrid Growth Method for Improved III-Nitride Tunnel Junction Devices
Phosphor-Free White Light Source
Control of Photoelectrochemical (PEC) Etching by Modification of the Local Electrochemical Potential of the Semiconductor Structure
Low Temperature Deposition of Magnesium Doped Nitride Films
Transparent Mirrorless (TML) LEDs
Improved GaN Substrates Prepared with Ammonothermal Growth
Laser Diode With Tunnel Junction Contact Surface Grating
Optimization of Laser Bar Orientation for Nonpolar Laser Diodes
High Efficiency Semipolar AlGaN-Cladding-Free Laser Diodes
Method for Enhancing Growth of Semipolar Nitride Devices
III-Nitride Tunnel Junction with Modified Interface
Growth of Polyhedron-Shaped Gallium Nitride Bulk Crystals
Nonpolar III-Nitride LEDs With Long Wavelength Emission
Improved Fabrication of Nonpolar InGaN Thin Films, Heterostructures, and Devices
Growth of High-Quality, Thick, Non-Polar M-Plane GaN Films
Increased Light Extraction with Multistep Deposition of ZnO on GaN
Method for Manufacturing Improved III-Nitride LEDs and Laser Diodes: Monolithic Integration of Optically Pumped and Electrically Injected III-Nitride LEDs
Selective-Area Mesoporous Semiconductors And Devices For Optoelectronic And Photonic Applications
High-Efficiency, Mirrorless Non-Polar and Semi-Polar Light Emitting Devices
Method for Growing High-Quality Group III-Nitride Crystals
Incorporating Temperature-Sensitive Layers in III-N Devices
Oxyfluoride Phosphors for Use in White Light LEDs
Technique for the Nitride Growth of Semipolar Thin Films, Heterostructures, and Semiconductor Devices
(In,Ga,Al)N Optoelectronic Devices with Thicker Active Layers for Improved Performance
MOCVD Growth of Planar Non-Polar M-Plane Gallium Nitride
Reduced Dislocation Density of Non-Polar GaN Grown by Hydride Vapor Phase Epitaxy
Heterogeneously Integrated GaN on Si Photonic Integrated Circuits
Al, In,Ga, BJN Device Structures
Reduction in Leakage Current and Increase in Efficiency of III-Nitride MicroLEDs
Methods for Fabricating III-Nitride Tunnel Junction Devices
Low-Droop LED Structure on GaN Semi-polar Substrates
Contact Architectures for Tunnel Junction Devices
Semi-polar LED/LD Devices on Relaxed Template with Misfit Dislocation at Hetero-interface
Photoelectrochemical Etching Of P-Type Semiconductor Heterostructures
Semipolar-Based Yellow, Green, Blue LEDs with Improved Performance
Growth of Semipolar III-V Nitride Films with Lower Defect Density
III-Nitride Tunnel Junction LED with High Wall Plug Efficiency
Improved Manufacturing of Solid State Lasers via Patterning of Photonic Crystals
Solid Solution Phosphors for Use in Solid State White Lighting Applications
Multifaceted III-Nitride Surface-Emitting Laser
Tunable White Light Based on Polarization-Sensitive LEDs
Cleaved Facet Edge-Emitting Laser Diodes Grown on Semipolar GaN
Growth of High-Performance M-plane GaN Optical Devices
Improved Anisotropic Strain Control in Semipolar Nitride Devices
High Light Extraction Efficiency III-Nitride LED
III-V Nitride Device Structures on Patterned Substrates